

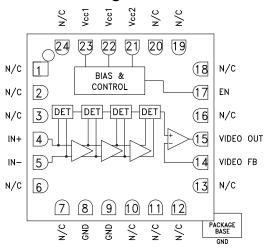


Typical Applications

The HMC613LC4B is ideal for:

- EW, ELINT & IFM Receivers
- DF Radar Systems
- ECM Systems
- Broadband Test & Measurement
- Power Measurement & Control Circuits
- Military & Space Applications

Functional Diagram



SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA), 0.1 - 20 GHz

Features

Wide Input Bandwidth; 0.1 to 20 GHz

High Logging Range: 59 dB (-54 to +5) @ 18 GHz

Output Frequency Flatness: ±1.5 dB

Log Linearity: ±1 dB

Fast Rise/Fall Times: 4/18 ns

Recovery Time: 26 ns

Single Positive Supply: +3.3V Space Level Packaging Available 24 Lead 4x4mm SMT Package: 16mm²

General Description

The HMC613LC4B is a Successive Detection Log Video Amplifier (SDLVA) which operates from 0.1 to 20 GHz. The HMC613LC4B provides a logging range of 59 dB. This device offers typical fast rise/fall times of 4/18 ns and a superior delay time of 14 ns. The HMC613LC4B log video output slope is typically 14 mV/dB. Maximum recovery times are less than 30 ns. The HMC613LC4B is available in a highly compact 4x4 mm SMT ceramic package and is ideal for high speed channelized receiver applications.

Electrical Specifications, $T_A = +25$ °C Vcc₁ = Vcc₂ = +3.3V

Parameter	Conditions	Тур.	Units
Input Frequency Range [1][2]		0.1 to 20	GHz
Frequency Flatness	Pin = -25 dBm	±1.5	dB
Log Linearity	Pin = -50 dBm to +3 dBm	±1	dBm
Log Linearity over Temperature	Pin = -25dBm	±1	dB
Minimum Logging Range	to ±3 dB error	-54 @ 18 GHz	dBm
Maximum Logging Range	to ±3 dB error	5 @ 18 GHz	dBm
Input Return Loss		8	dB
Log Video Minimum Output Voltage		1	V
Log Video Maximum Output Voltage		1.8	V
Log Video Output Rise Time	10% to 90%	4	ns
Log Video Output Fall Time	90% to 10%	18	ns
Log Video Recovery Time		26	ns
Log Video Output Slope		14	mV/dB
Log Video Output Slope Variation over Temperature	@ 10 GHz	5	μV/dB°C
Log Video Propagation Delay		14	ns
Supply Current (Icc1)		80	mA
Supply Current (Icc2)	@ Pin = -30 dBm	8	mA

[1] Electrical specs and performance plots are given for single-ended operation

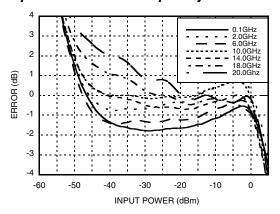
Application Sup

[2] Video output load should be 1K Ohm or higher.

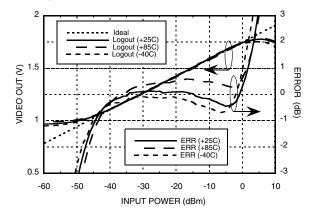




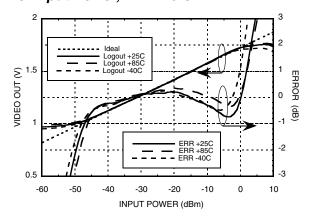
Error Flatness vs. Input Power Over Frequency [1][2]



VIDEO OUT & Error vs. Input Power, Fin = 2 GHz [1]

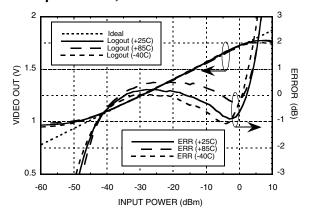


VIDEO OUT & Error vs. Input Power, Fin = 10 GHz [1]

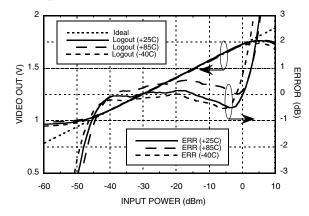


SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA), 0.1 - 20 GHz

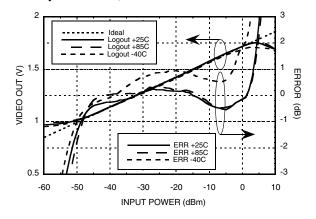
VIDEO OUT & Error vs. Input Power, Fin = 100 MHz [1]



VIDEO OUT & Error vs. Input Power, Fin = 6 GHz [1]



VIDEO OUT & Error vs. Input Power, Fin = 14 GHz [1]



[1] Electrical Specs and performance plots are given at single-ended operation

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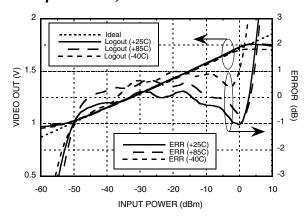
[2] An average ideal line is used to calculate error curves.

Ph n : 978-259-3343 or apps@hittle.co

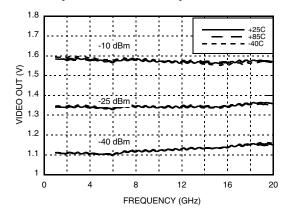




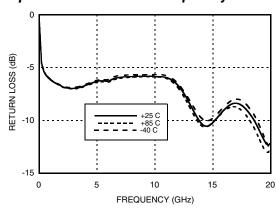
VIDEO OUT & Error vs. Input Power, Fin = 18 GHz [1]



VIDEO OUT vs. Frequency Over Input Power & Temperature [1]

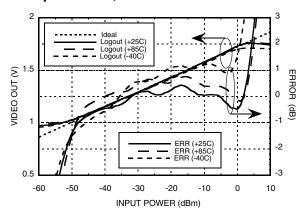


Input Return Loss vs. Frequency [1]

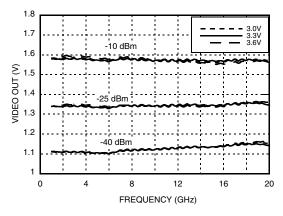


SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA), 0.1 - 20 GHz

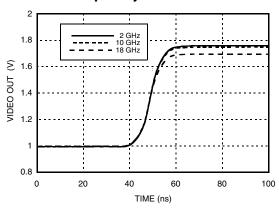
VIDEO OUT & Error vs. Input Power, Fin = 20 GHz [1]



VIDEO OUT vs. Frequency Over Input Power & Bias Voltage [1]



Rise Time @ Different Frequency @ 0 dBm [1]

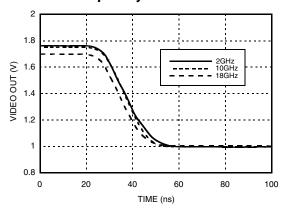


[1] Electrical Specs and performance plots are given at single-ended operation



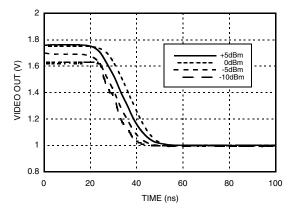


Fall Time @ Different Frequency @ 0 dBm [1]



SUCCESSIVE DETECTION LOG VIDEO AMPLIFIER (SDLVA), 0.1 - 20 GHz

Fall Time @ Different Power Levels @ 10 GHz [1]



Absolute Maximum Ratings

Vcc1, Vcc2	3.7 V
Input Signal Amplitude	12 dBm
Junction Temperature	125 °C
Continuous Pdiss (T=85 °C) Derate 11.5 mW/°C above 85 °C	0.46 W
Thermal Resistance (R _{th}) (junction to package bottom)	87.1 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 0

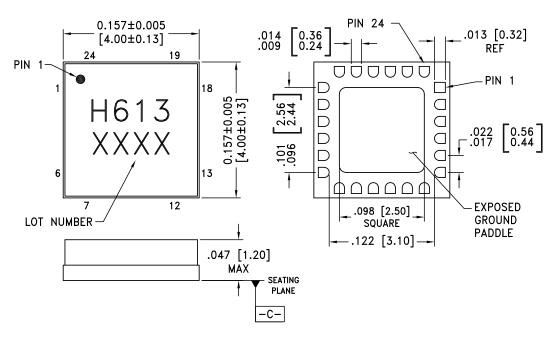






Outline Drawing

BOTTOM VIEW



NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD
- OVER 50 MICROINCHES MINIMUM NICKEL.
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE
- SOLDERED TO PCB RF GROUND.
- 7. CLASSIFIED AS MOISTURE SENSITIVITY LEVEL (MSL) 1.

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 2, 7, 10 - 12, 18, 19	N/C	These pins are not internally connected.	
3, 6, 13, 16, 20, 24	N/C	These pins are not connected internally. However, this product is specified with these pins connected to RF/DC Ground.	
4, 5	IN+, IN-	RF Input pins Connect RF to IN+, and AC couple IN- to ground for single ended operation.	IN+ Ο





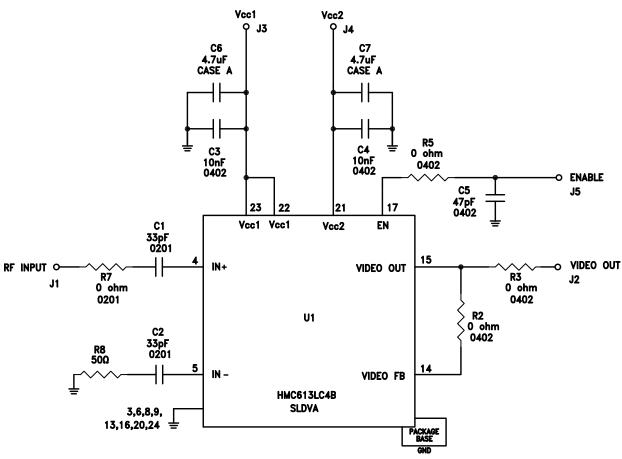
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
8, 9	GND	These pins and the exposed package bottom must be connected to a high quality RF/DC ground.	⊖ GND <u>=</u>
14, 15	Video FB, Video Out	Video out and feedback. These pins should be shorted to each other (see application circuit). Video out load should be at least 1K Ohm or higher.	Vcc2 Vcc2 Vcc2 Vcc2 Vcc2 ViDEO VIDEO FB
17	EN	Enable pin connected to Vcc1 or Vcc2 for normal operation. Total supply current reduced to less than 3mA when EN is set to 0V.	Vcc1 R=1.25k EN O
21	Vcc2	Bias Supply. Connect supply voltage to these pins with appropriate filtering. Connect Vcc2 with Vcc1. See application circuit.	Vcc2 ESD ESD
22, 23	Vcc1	Bias Supply. Connect Supply Voltage to these pins with appropriate filtering. Connect Vcc2 with Vcc1. See application circuit.	Vcc10 ESD





Application Circuit



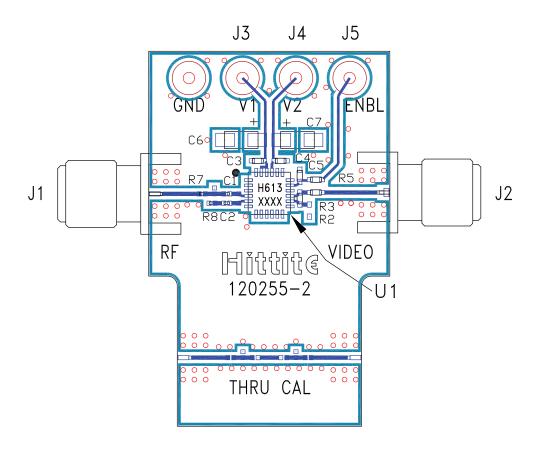
Note1: Connect Vcc2 and Vcc1 together for Nominal operation.

Note2: Video output load should be 1K Ohm or higher.





Evaluation PCB



List of Materials for Evaluation PCB 120257 [1]

Item	Description
J1	K-Type Connector
J2	SMA Connector
J3 - J5	DC Pins
C1, C2	33 pF Capacitor, 0201 Pkg.
C3, C4	10k pF Capacitor, 0402 Pkg.
C5	47 pF Capacitor, 0402 Pkg.
C6, C7	4.7 μF Capacitor, CASE A Pkg.
R2, R3, R5	0 Ohm Resistor, 0402 Pkg.
R7	0 Ohm Resistor, 0201 Pkg.
R8	49.9 Ohm Resistor, 0201 Pkg.
U1	HMC613LC4B SDLVA
PCB [2]	120255 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25 FR

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.